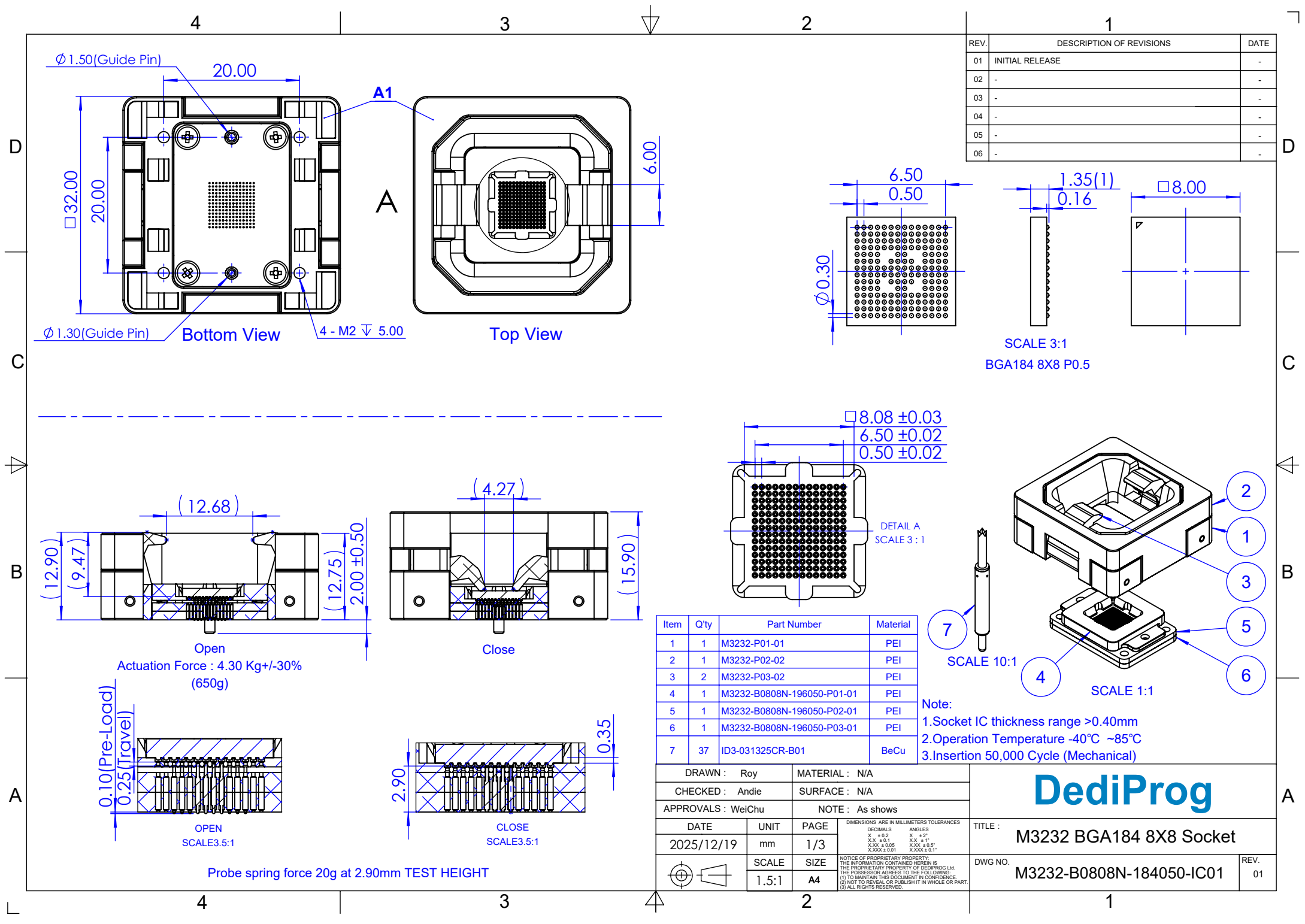
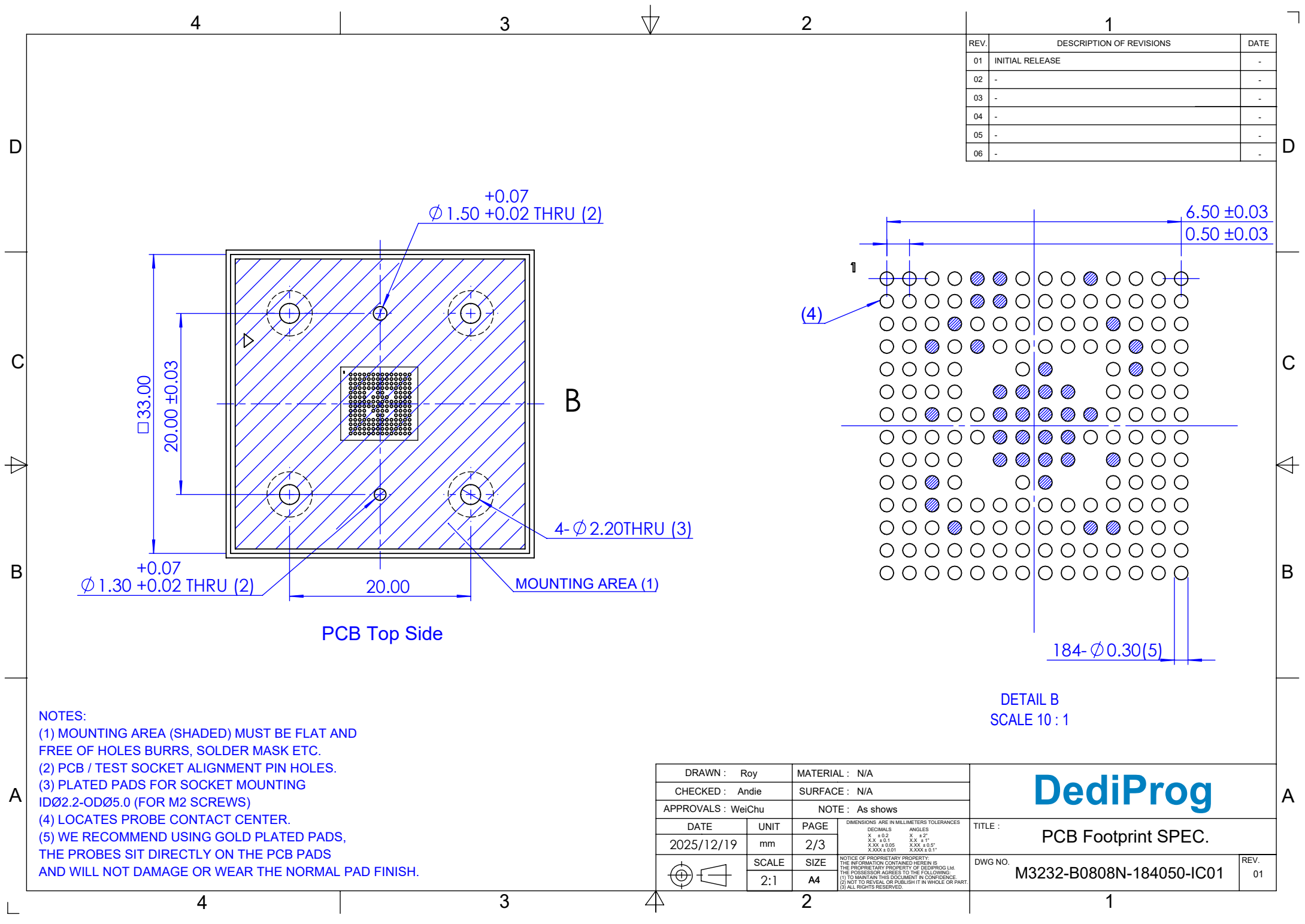




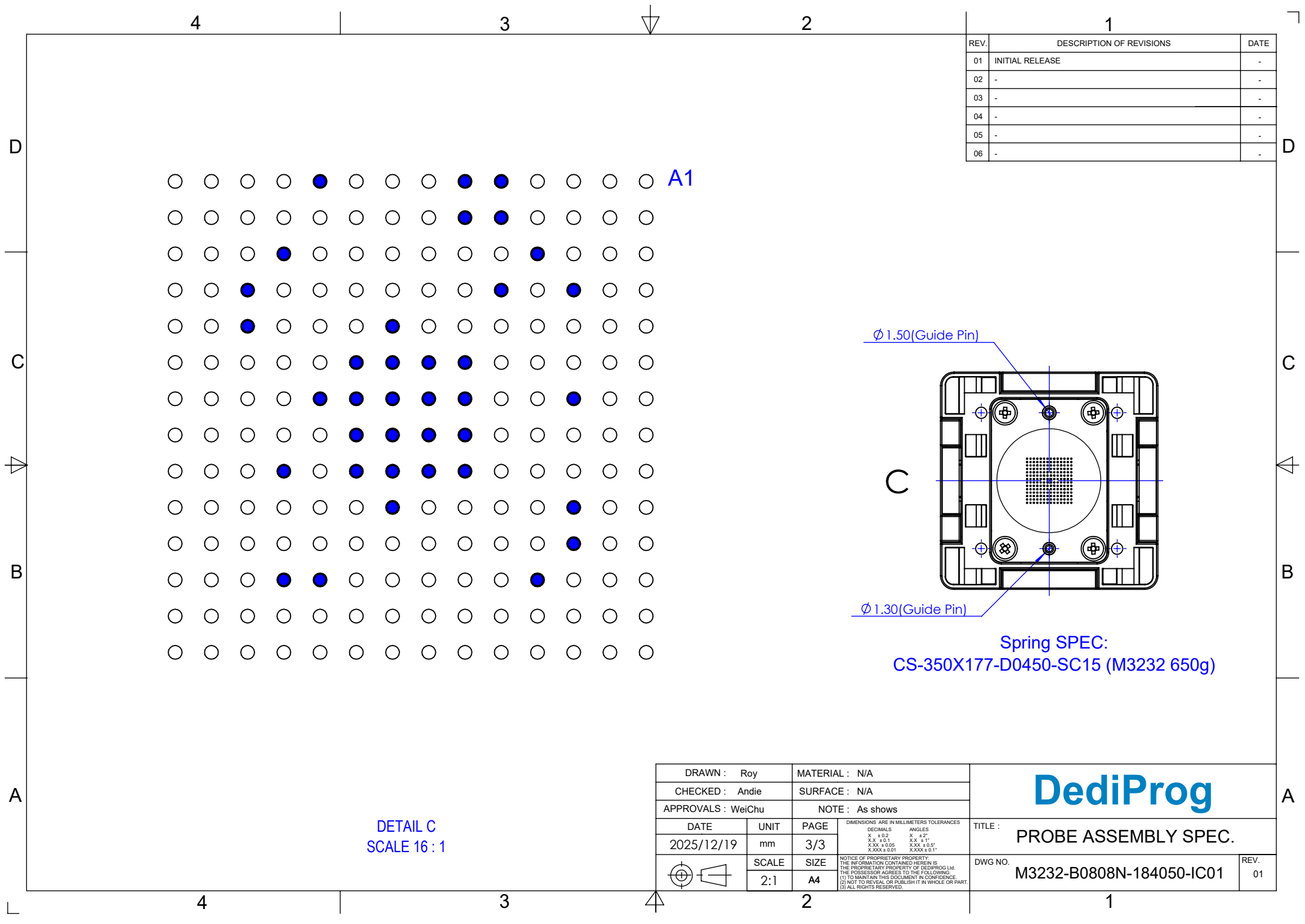


REV.	DESCRIPTION OF REVISIONS	DATE
01	INITIAL RELEASE	-
02	-	-
03	-	-
04	-	-
05	-	-
06	-	-

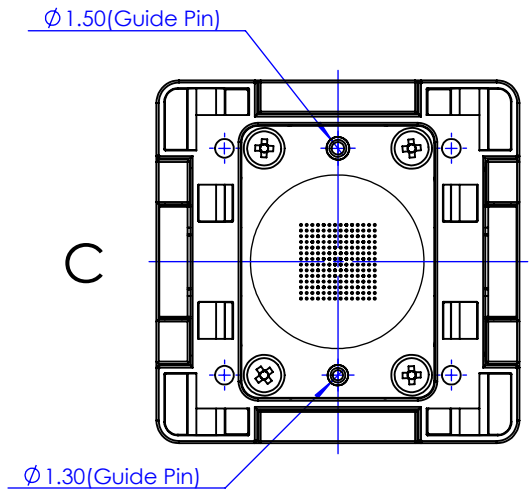
NOTES:
(1) MOUNTING AREA (SHADED) MUST BE FLAT AND FREE OF HOLES BURRS, SOLDER MASK ETC.
(2) PCB / TEST SOCKET ALIGNMENT PIN HOLES.
(3) PLATED PADS FOR SOCKET MOUNTING IDØ2.2-ODØ5.0 (FOR M2 SCREWS)
(4) LOCATES PROBE CONTACT CENTER.
(5) WE RECOMMEND USING GOLD PLATED PADS, THE PROBES SIT DIRECTLY ON THE PCB PADS AND WILL NOT DAMAGE OR WEAR THE NORMAL PAD FINISH.

DETAIL B
SCALE 10 : 1

DRAWN : Roy		MATERIAL : N/A		DediProg	
CHECKED : Andie		SURFACE : N/A			
APPROVALS : WeiChu		NOTE : As shows			
DATE	UNIT	PAGE	DIMENSIONS ARE IN MILLIMETERS TOLERANCES DECIMALS ANGLES X ± 0.2 X ± 2° XX ± 0.1 XX ± 1° XXX ± 0.05 XXX ± 0.5° XXX ± 0.01 XXX ± 0.1°	TITLE :	PCB Footprint SPEC.
2025/12/19	mm	2/3		DWG NO.	
 SCALE		SIZE	REV.		
2:1		A4	01		



1		
REV.	DESCRIPTION OF REVISIONS	DATE
01	INITIAL RELEASE	-
02	-	-
03	-	-
04	-	-
05	-	-
06	-	-



Spring SPEC:
CS-350X177-D0450-SC15 (M3232 650g)

DETAIL C
SCALE 16 : 1

DRAWN : Roy		MATERIAL : N/A		DediProg TITLE : PROBE ASSEMBLY SPEC.	
CHECKED : Andie		SURFACE : N/A			
APPROVALS : WeiChu		NOTE : As shows			
DATE	UNIT	PAGE	DIMENSIONS ARE IN MILLIMETERS TOLERANCES		
2025/12/19	mm	3/3	DECIMALS ANGLES		
			X ± 0.2 X ± 2°		
			XX ± 0.1 XX ± 1"		
			X.XX ± 0.05 XX ± 0.5"		
			X.XXX ± 0.01 XXX ± 0.1"		
		SCALE	SIZE	DWG NO.	
		2:1	A4	M3232-B0808N-184050-IC01	
NOTICE OF PROPRIETARY PROPERTY: THE INFORMATION CONTAINED HEREIN IS THE PROPRIETARY PROPERTY OF DEDIPROG Ltd. THE POSSESSOR AGREES TO THE FOLLOWING: (1) TO MAINTAIN THIS DOCUMENT IN CONFIDENCE. (2) NOT TO REVEAL OR PUBLISH IT IN WHOLE OR PART (3) ALL RIGHTS RESERVED.					
				REV.	01